

## **LOCTITE ABLESTIK ABP 3533**

July 2023

#### PRODUCT DESCRIPTION

LOCTITE ABLESTIK ABP 3533 provides the following product characteristics:

Technology	Epoxy	
Appearance	Silver	
Product benefits	<ul> <li>One component</li> <li>Good workability</li> <li>High reliability</li> <li>Good electrical and thermal conductivity</li> <li>Good adhesion on non-BSM and BSM die</li> <li>Low stress</li> <li>Moderate modulus</li> <li>Low outgassing</li> </ul>	
Cure	Heat cure	
Application	Electronic adhesives; Semiconductor pastes	
Typical package application	SOIC, SOP, QFP and QFN	
Key substrates	Ag, Cu, PPF	

LOCTITE ABLESTIK ABP 3533 electrically conductive die attach adhesive is formulated for use on high reliability package applications. It provides excellent conductivity to achieve low RDSon in MOSFET electronic devices.

This material is designed with the moderate modulus, good adhesion and low stress, making it suitable for bonding non-BSM (backside metallization) and BSM die, ranging from small to large die sizes.

The above cure profile are guideline recommendations. These conditions (time and temperature) may vary based on customers' experience and specific application requirements, as well as customer curing equipment, oven loading and actual oven temperatures.

### TYPICAL PROPERTIES OF CURED MATERIAL

## **Physical Properties**

Coefficient of thermal expansion, ppm/°C	
Below Tg	90
Above Tg	213
Glass transition temperature, Tg by TMA, °C	32
Dynamic tensile modulus (DMA), MPa	
@-65°C	5,950
@25°C	4,300
@150°C	130
@200°C	130
@250°C	130
Extractable ionic content, ppm	
Chloride (CI-)	≤20
Sodium (Na+)	≤10
Potassium (K+)	≤10
Thermal conductivity, W/mK	3.8

#### **Electrical properties**

Volume resistivity, ohm-cm 1.0 x 10<sup>-4</sup>

### TYPICAL PROPERTIES OF UNCURED MATERIAL

Viscosity, Brookfield CP51 @ 25°C, mPa·s (cP) Speed 5 rpm	7000
Thixotropic index, (0.5/5 rpm)	4.0
Work life @ 25°C, hours	24
Shelf life @ -40°C, days	365

### **TYPICAL CURING PERFORMANCE**

Weight loss, on cure by TGA @ 175°C 2.7

## Recommended cure

30 minutes ramp to 175°C + 60 minutes in N2 or air

#### Alternate cure

30 minutes ramp to 200°C + 60 minutes in N2 or air

#### TYPICAL PERFORMANCE OF CURED MATERIAL

### Shear strength

Die shear strength, 2x2 mm die, kg-f	
on Ag leadframe	
@RT	12.0
@260°C	1.4
on Cu leadframe	
@RT	8.0
@260°C	1.5
on PPF leadframe	
@RT	10.0
@260°C	1.3



#### **GENERAL INFORMATION**

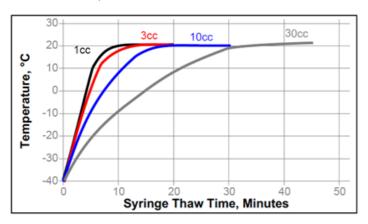
Please consult the Safety Data Sheet (SDS) for safe handling information of this product.

#### Thawing:

- 1. Allow container to reach room temperature before use.
- 2. After removing from the freezer, set the syringes to stand vertically while thawing.
- 3. Thaw times depend on the syringe size.
- 4. Consult handling guide for more information.
- 5. DO NOT open the container before contents reach 25°C temperature. Any moisture that collects on the thawed container should be removed prior to opening the container.
- DO NOT re-freeze. Once thawed to 25°C, the adhesive should not be re-frozen.

### **Product specification**

The technical data contained herein are intended as reference only and are not considered specifications for the product. Product specifications are located on the Certificate of Analysis or please contact Henkel representative.



#### **Directions for use**

- 1. Thawed material should immediately be placed on dispense equipment for use.
- If the adhesive is transferred to a final dispensingreservoir, care must be exercised to avoid entrapment of contaminants and/or air into the adhesive.
- 3. Adhesive must be completely used within the product's recommended work life.
- Alternate dispense amounts may be used depending on the application requirements.

## Storage:

Store product in an unopened container in a dry location. Storage information may be indicated on the product container labeling.

# Optimal Storage: -40°C. Storage below -40°C or greater than -40°C can adversely affect product properties.

Material removed from containers may be contaminated during use. Do not return product to the original container. Henkel cannot assume responsibility for product which has beencontaminated or stored under conditions other than those previously indicated. If additional information is required, please contact your local Henkel representative.

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### Conversions

(°C x 1.8) + 32 = °F kV/mm x 25.4 = V/mil mm / 25.4 = inches  $\mu$ m / 25.4 = mil N x 0.225 = lb N/mm x 5.71 = lb/in N/mm² x 145 = psi MPa x 145 = psi N·m x 8.851 = lb·in N·m x 0.738 = lb·ft N·mm x 0.142 = oz·in mPa·s = cP



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Reference 1